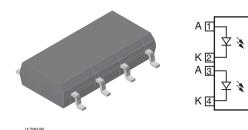


Vishay Semiconductors

Dual 1 Form A Solid State Relay



DESCRIPTION

The LH1556FP is robust, ideal for telecom and ground fault applications. It contains two SPST normally open switches (1 form A) that replace electromechanical relays in many applications. It is constructed using a GaAs LED for actuation control and an integrated monolithic die for the switch output. The die, fabricated in a high-voltage dielectrically isolated BCDMOS technology, is comprised of a photodiode array, switch control circuitry and MOSFET switches. In addition, it employs current-limiting circuitry which meets FCC 68.302 and other regulatory voltage surge requirements when overvoltage protection is provided.

FEATURES

- · Solid-state relay (equivalent to AQW210S)
 - Typical R_{ON} 28 Ω
 - Load voltage 350 V
 - Load current 120 mA
 - Current limit protection
 - High surge capability
 - Clean bounce free switching
 - Low power consumption
 - High reliability monolithic detetor
- · Two independent relays in a single package
- Package flat pak
- Isolation test voltage, 3000 V_{RMS}
- Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC

APPLICATIONS

- General telecom switching
 - On/off hook control
- Ring relay
- Ground start
- · Industrial controls
 - Triac predriver
 - Output modules
- Peripherals
 - Transducer driver
- Instrumentation
 - Automatic tuning/balancing
 - Flying capacitor
 - Analog multiplexing

Note

See "solid state relays" (application note 56)

AGENCY APPROVALS

UL1577: file no. E52744 system code O

BSI/BABT: certification no. 7980

ORDER INFORMATION					
PART	REMARKS	PACKAGE			
LH1556FP	Tubes	SMD-8			
LH1556FPTR	Tape and reel	SMD-8			

LH1556FP/LH1556FPTR

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ABSOLUTE MAXIMUM RATINGS (1)									
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT					
SSR									
LED continuous forward current		I _F	50	mA					
LED reverse voltage	I _R ≤ 10 μA	V_{R}	6.0	V					
DC or peak AC load voltage	$I_L \le 50 \ \mu A$	V_L	350	V					
Continuous DC load current		ΙL	120	mA					
Ambient temperature range		T _{amb}	- 40 to + 85	°C					
Storage temperature range		T _{stg}	- 40 to + 125	°C					
Soldering temperature (2)	t = 10 s max.	T _{sld}	260	°C					
Isolation test voltage	t = 1.0 s	V _{ISO}	3000	V _{RMS}					
Isolation resistance	V _{IO} = 500 V, T _{amb} = 25 °C	R _{IO}	≥ 10 ¹²	Ω					
	V _{IO} = 500 V, T _{amb} = 100 °C	R _{IO}	≥ 10 ¹¹	Ω					
Total power dissipation		P _{diss}	550	mW					

Notes

⁽²⁾ Refer to reflow profile for soldering conditions for surface mounted devices.

ELECTRICAL CHARACTERISTICS								
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT		
INPUT								
LED forward current, switch turn-on	$I_L = 100 \text{ mA}, t = 10 \text{ ms}$	I_{Fon}		1.1	2.0	mA		
LED forward current, switch turn-off	$V_{L} = \pm 300 \text{ V}$	I _{Foff}	0.2	0.6		mA		
LED forward voltage	I _F = 10 mA	V_{F}	1.0	1.18	1.45	V		
Current limit	I_F = 5.0 mA, t = 5.0 ms, V_L = \pm 6.0 V	I _{Limit}	170	210	250	mA		
OUTPUT								
On-resistance AC/DC: pin 3 (±) to 4 (±)	$I_F = 5.0 \text{ mA}, I_L = 50 \text{ mA}$	R _{ON}		28	35	Ω		
Off-resistance	$I_F = 0 \text{ mA}, V_L = \pm 100 \text{ V}$	R _{OFF}	0.5	300		GΩ		
Off-state leakage current	$I_F = 0 \text{ mA}, V_L = \pm 100 \text{ V}$	Ιο		0.32	200	nA		
	$I_F = 0 \text{ mA}, V_L = \pm 350 \text{ V}$	Ιο			1.0	μΑ		
Output capacitance pin 3 to 4	$I_F = 0 \text{ mA}, V_L = 1.0 \text{ V}$	Co		55		pF		
	$I_F = 0 \text{ mA}, V_L = 50 \text{ V}$	Co		10		pF		
TRANSFER								
Turn-on time	$I_F = 5.0 \text{ mA}, I_L = 50 \text{ mA}$	t _{on}		2.0	3.0	ms		
Turn-off time	$I_F = 5.0 \text{ mA}, I_L = 50 \text{ mA}$	t _{off}		1.1	3.0	ms		
Capacitance (input to output)	V _{ISO} = 1.0 V	C _{IO}		0.6		pF		

Note

 T_{amb} = 25 °C, unless otherwise specified.

Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information only and are not part of the testing requirements.

⁽¹⁾ T_{amb} = 25 °C, unless otherwise specified.

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.

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TYPICAL CHARACTERISTICS

T_{amb} = 25 °C, unless otherwise specified

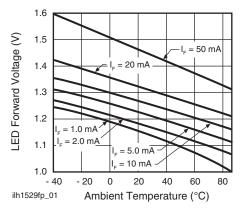


Fig. 1 - LED Voltage vs. Temperature

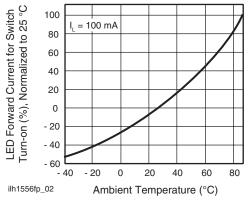


Fig. 2 - LED Current for Switch Turn-on vs. Temperature

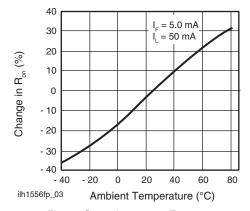


Fig. 3 - On-resistance vs. Temperature

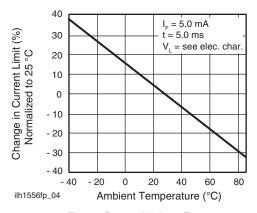


Fig. 4 - Current Limit vs. Temperature

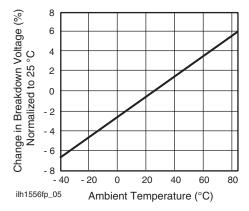


Fig. 5 - Switch Breakdown Voltage vs. Temperature

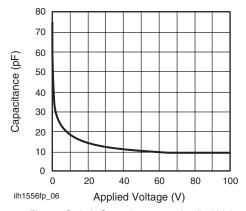


Fig. 6 - Switch Capacitance vs. Applied Voltage

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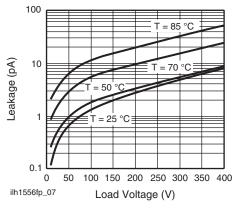


Fig. 7 - Leakage Current vs. Applied Voltage

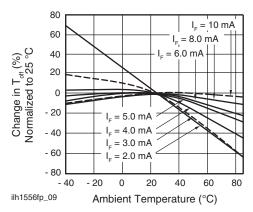


Fig. 9 - Turn-off Time vs. Temperature

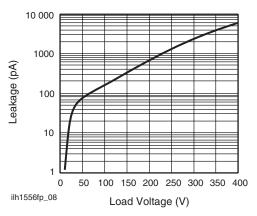


Fig. 8 - Leakage Current vs. Applied Voltage

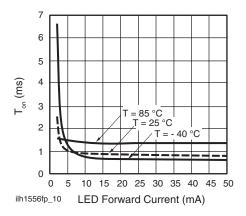
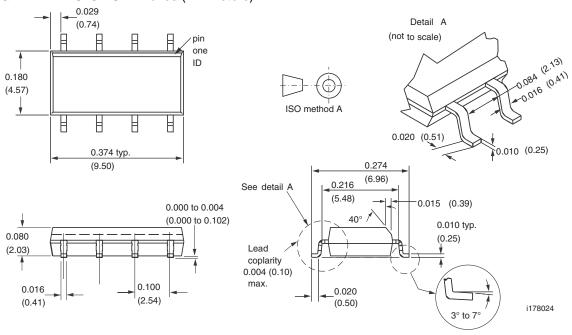


Fig. 10 - Turn-on Time vs. LED Current

PACKAGE DIMENSIONS in inches (millimeters)



LH1556FP/LH1556FPTR



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OZONE DEPLETING SUBSTANCES POLICY STATEMENT

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively.
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA.
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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Vishay

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